

PATENT ASSIGNMENT COVER SHEET

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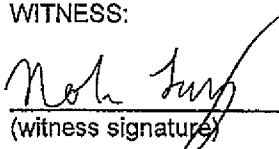
SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NEIL BARNETT	08/08/2017
SCOTT DIETSCH	08/08/2017
RECEIVING PARTY DATA	
Name:	MACDON INDUSTRIES LTD
Street Address:	680 MORAY STREET
City:	WINNIPEG
State/Country:	CANADA
Postal Code:	R3J 3S3
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15642526
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Email:	uspto@adeco.com
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Address Line 4:	WINNIPEG, CANADA R2G 1P9
ATTORNEY DOCKET NUMBER:	80070-178US/ADB
NAME OF SUBMITTER:	ADRIAN D BATTISON
SIGNATURE:	/Adrian D Battison/
DATE SIGNED:	08/25/2017
Total Attachments: 2	
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ASSIGNMENT

We, Neil Barnett, whose full post office address is 848 Walter Run, Waunakee, WI, 53597, US, and Scott Dietsche, whose full post office address is 1299 Prospect Common Apt. 104, Sun Prairie, WI, 53590, US, in consideration of \$1.00 and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, do hereby sell and assign to MacDon Industries Ltd., whose full post office address is 680 Moray Street, Winnipeg, MB, R3J 3S3, Canada, all our interest in the United States, Canada and in all other countries in and to our invention relating to a Draper Header for Attachment to a Harvesting Machine, as fully described and claimed in our United States application for a patent for such invention, filed July 6, 2017, under Serial No. 15/642,526, and any and all divisional and continuation applications, together with the right to claim priority from said application under the International Convention and the entire right, title and interest in and to said application, and in and to any and all other applications filed for said invention, including said any and all divisional and continuation applications and any and all applications claiming priority from said application under the International Convention, and the entire right, title and interest in and to and any and all Letters Patent which may issue or be re-issued for said invention to the full end of the term for which each said Letters Patent may be granted; and hereby authorize the issuance to said assignee of any and all said Letters Patent not already issued as the assignee of the entire right, title and interest in and to the same, for the sole use and benefit of said assignee, its successors, assigns or legal representatives; and hereby covenant and agree to do all such lawful acts and things and to execute without further consideration such further lawful assignments, documents, assurances, applications, and other instruments as may reasonably be required by said assignee, its successors, assigns or legal representatives, to obtain any and all Letters Patent for said invention and vest the same in said assignee, its successors, assigns or legal representatives.

Signed at Madison, WI, USA
(city/town, province/state, country)

This 8th day of August, 2017
(day) (month) (year)

WITNESS:

(witness signature)


signature of Neil Barnett

Signed at Madison, WI, USA
(city/town, province/state, country)

This 8th day of August, 2017
(day) (month) (year)

WITNESS:

Chrese Walt
(witness signature)

Scott C. Dietsche
signature of Scott Dietsche